



- Notes:
1. Materials:
    - 1.1 Housing: High temperature thermoplastic with g.f.U.L94 v-0.
    - 1.2 Contact: copper alloy,t=0.20mm.
    - 1.3 Shell: copper alloy,t=0.25mm.
  2. Specifications:
    - 2.1. Current rating: 1 A Max.
    - 2.2. Dielectric withstanding voltage: 100 V(ac) for 1 min.
    - 2.3. Contact resistance: 50 mW Max.
    - 2.4. Insulation resistance: 100 MW Min.
    - 2.5. Total mating force: 3.57 KgF Max.
    - 2.6. Total unmating force: 1.0 KgF Min,0.81~2.05 KgF Min,after 10000 insertion/extraction cycles
    - 2.7. Temperature range: -30° C~+80° C

<b>UNITS:</b> mm		<b>CSCCONN</b>		SHENZHEN CSCCONN PRECISE ELECTRONICS CO.,LTD	
<b>GENERAL TOLERANCE:</b>		<b>PART NO.(INTENDED USE)</b>		<b>TITLE:</b>	
X ± 5°	0.X ± 0.3	CMU06581C117		MICRO USB 5P SMT 沉板式	
X1 ± 2°	0.XX ± 0.2	<b>APPD:</b>		<b>DWG NO.</b>	
XX ± 1°	0.XXX ± 0.1	SK11a		MICRO USB	
XXX ± 0.3°		<b>CHKD:</b>		<b>SCALE</b>	
		DR: Kitty		1:1	
				<b>SHEET</b>	
				1 OF 1	
				<b>REV</b>	
				A	